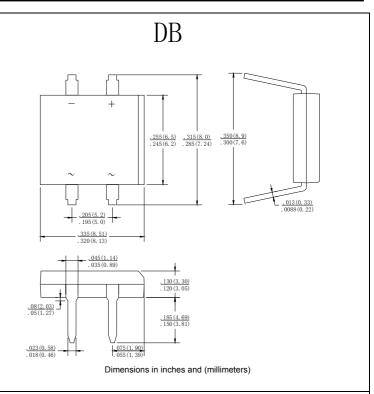


## Features

- · Ideal for printed circuit board
- Reliable low cost construction technique results in inexpensive product
- High temperature soldering guaranteed: 260°C / 10 seconds / 0.375" (9.5mm) lead length at 5 lbs., (2.3 kg) tension

## **Mechanical Data**

- Case: Molded plastic
- · Lead: solder plated
- · Polarity: As marked



## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating at 25  $^\circ\!\mathrm{C}$   $\,$  ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load.

For capacitive load, derate current by 20%

Type Number		DB151G	DB152G	DB153G	DB154G	DB155G	DB156G	DB157G	UNITS
Maximum Repetitive Peak Reverse Voltage	VRRM	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	VRMS	35	70	140	280	420	560	700	V
Maximum DC blocking Voltage	VDC	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current $@T_A = 40 \degree$ C	l(AV)	1.5						А	
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method )	I <sub>FSM</sub>	50						А	
Maximum Instantaneous Forward Voltage @ 1.5A	V <sub>F</sub>	1.1						V	
Maximum DC Reverse Current @ TA=25 $^\circ\!\!\mathbb{C}$ rated DC blocking voltage per leg TA = 125 $^\circ\!\!\mathbb{C}$	I <sub>R</sub>	10 500							μA
Typical Thermal Resistance (Note)	R θ ja R θ jl	40 15							°C/W
Operating Temperature Range	TJ	-55 to +150							°C
Storage Temperature Range	Tstg	-55 to +150							°C

**NOTE:** Thermal Resistance from Junction to Ambient and from Junction to Lead Mounted on P.C.B.with 0. 47×0. 47" (12×12mm) Copper

Pads.



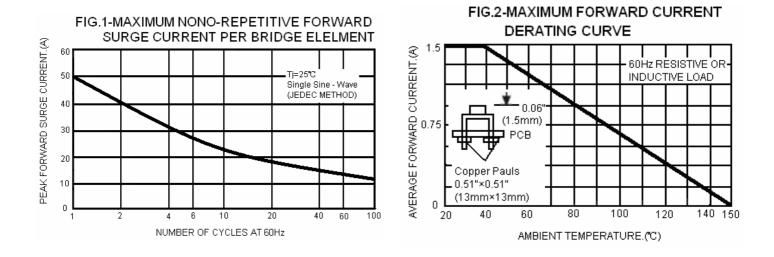


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS PER BRIDGE ELEMENT

